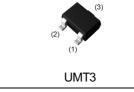


NPN General purpose transistor

Datasheet



## AEC-Q101 Qualified



### Features

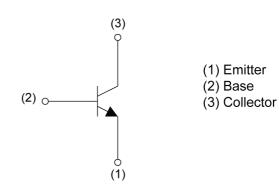
- $1)BV_{CEO}>45V(I_{C}=1mA)$
- 2)Complements the BC857BU3 HZG.

### Inner circuit

Outline

SOT-323

SC-70



### Application

AUDIO FREQUENCY SMALL SIGNAL AMPLIFIER

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
BC847BU3HZG	SOT-323 (UMT3)	2021	T106	180	8	3000	G1F

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Values	Unit
Collector-base voltage	V <sub>CBO</sub>	50	V
Collector-emitter voltage	V <sub>CEO</sub>	45	V
Emitter-base voltage	V <sub>EBO</sub>	6	V
Collector current	I <sub>C</sub>	100	mA
Power dissipation	P <sub>D</sub> <sup>*1</sup>	200	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	Ι <sub>C</sub> = 50μΑ	50	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	45	-	-	V	
Emitter-base breakdown voltage	$BV_{EBO}$	Ι <sub>Ε</sub> = 50μΑ	6	-	-	V	
Collector out off ourrent		V <sub>CB</sub> = 30V	-	-	15	nA	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 30V, T <sub>a</sub> = 150°C	-	-	5	μA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> 1	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0.5mA	-	-	250	mV	
	V <sub>CE(sat)</sub> 2	I <sub>C</sub> = 100mA, I <sub>B</sub> = 5mA	-	-	600	mV	
Base-emitter turn on voltage	V <sub>BE(on)</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 10mA	580	-	700	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 2mA	200	-	450	-	
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 5V, I <sub>E</sub> = -20mA, f = 100MHz	-	200	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A f = 1MHz	-	3.0	-	pF	
Input capacitance	C <sub>ib</sub>	V <sub>BE</sub> = 0.5V, I <sub>C</sub> = 0A f = 1MHz	-	8.0	-	pF	

\*1 Each terminal mounted on a reference land.



## • Electrical characteristic curves( $T_a = 25^{\circ}C$ )

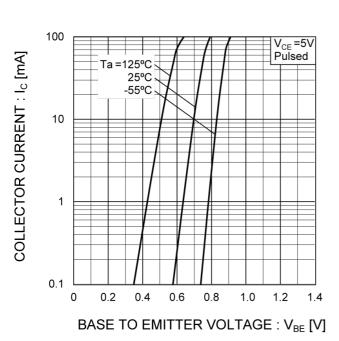


Fig.1 Ground Emitter Propagation Characteristics

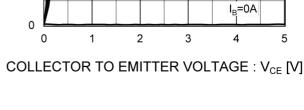


Fig.3 DC Current Gain vs. Collector Current (I)

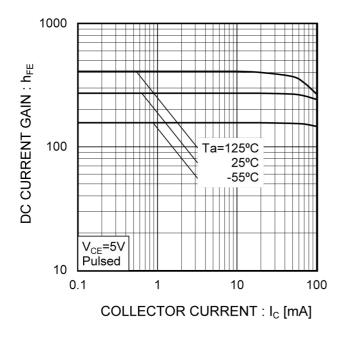


Fig.4 DC Current Gain vs. Collector Current (II)

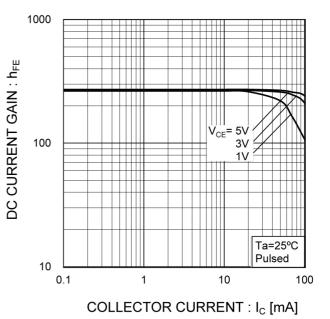


Fig.2 Grounded Emitter Output Characteristics

100

80

60

40

20

COLLECTOR CURRENT : I<sub>c</sub> [mA]

Ta=25⁰C

Pulsed

500µA

450µA

400µA

350µA

300µA

250µA

200µA

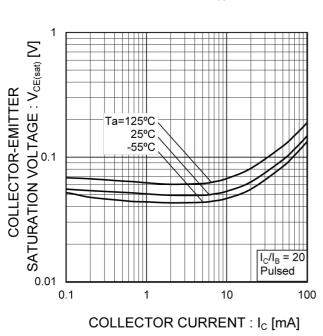
150µA

100µA

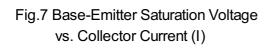
50µA

5

## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )



# Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)



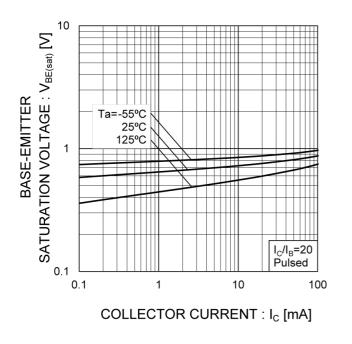


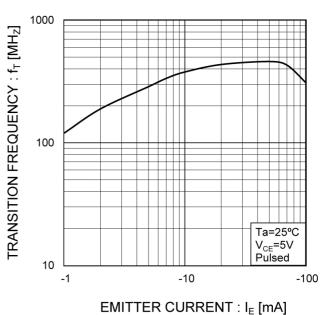
Fig.8 Gain Bandwith Product vs. Emitter Current

1

10

COLLECTOR CURRENT : Ic [mA]

100



# Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

Ta=25°C

~/I\_=50

=20

=10

Pulsed

SATURATION VOLTAGE : V<sub>CE(sat)</sub> [V] .

0.01

COLLECTOR-EMITTER

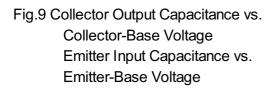
1ms 10ms

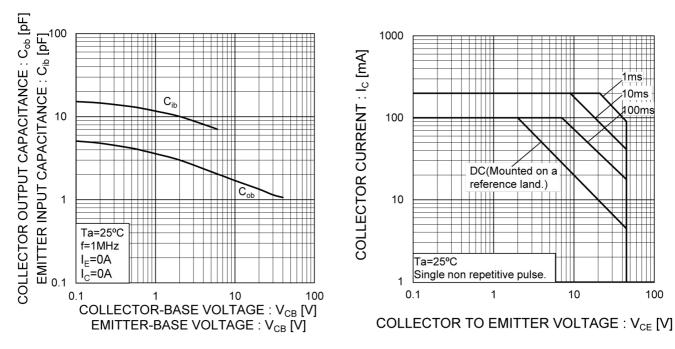
100ms

100

Fig.10 Safe Operating Area

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

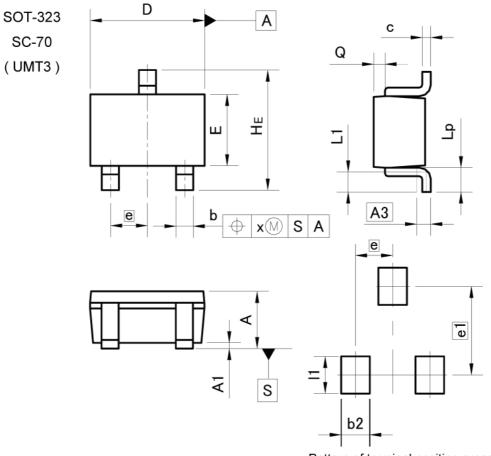






### BC847BU3HZG

### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIN	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0	0.004	
A3	0.2	25	0.0	D1	
b	0.25	0.40	0.01	0.016	
с	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.65		0.03		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.02	
Lp	0.25	0.55	0.01	0.022	
Q	0.10	0.30	0.004	0.012	
x	-	0.10	-	0.004	

DIM	MILIM	ETERS	INCHES		
DIN	MIN	MAX	MIN	MAX	
e1	1.55		0.06		
b2	-	0.50	-	0.02	
1	-	0.65	-	0.026	

Dimension in mm/inches



## Notice

### **Precaution on using ROHM Products**

If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Ap	pplications
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JAPAN	USA	EU	CHINA
CLASSII	CLASSⅢ	CLASS II b	CLASSII
CLASSIV	CLASS III	CLASSⅢ	CLASSII

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[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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